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PATENT APPLICATION

DOCKET NO. HA01-P01

IN THE  
UNITED STATES PATENT AND TRADEMARK OFFICE

RECEIVED  
MAY 01 2003  
TECHNOLOGY CENTER R3700

INVENTOR: Mark Rupert TUCKER

SERIAL NO.: 09/673,221

GROUP ART UNIT: 3721

FILING DATE: October 6, 2000

EXAMINER: NASH, Brian D.

TITLE: Method of Manufacturing Transdermal Patches

ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231

RESPONSE TO OFFICE ACTION AND  
REQUEST FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136(a)

SIR OR MADAM:

This Response is to the Office action dated November 25, 2002.

Claim Summary:

Claims originally present: 1-19.  
Claims previously canceled: none.  
Claims previously amended: none.  
Claims previously added: none.  
Claims hereby canceled: 1 through 19.  
Claims hereby amended: none.  
Claims hereby being added: 20 through 39.  
Claims remaining: 20-39(new).

04/11/2003 MDAMTE1 00000014 09673221

01 FC:2251 55.00 OP

04/11/2003 MDAMTE1 00000014 09673221

02 FC:1202 18.00 OP

S/N: 09/673,221  
Amendment A